

Exploiting the Close-to-Dirac Point Shift of the Fermi Level in the $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ Topological Insulator Heterostructure for Spin-Charge Conversion

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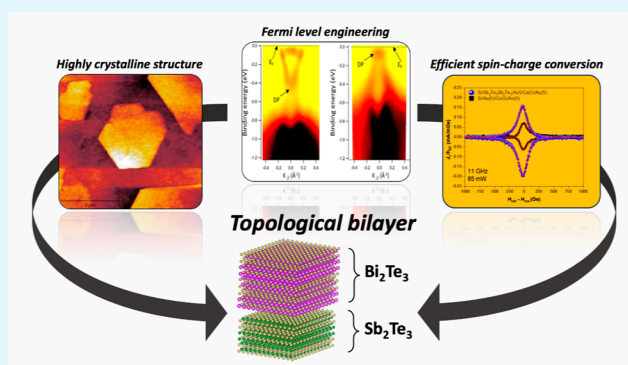
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ABSTRACT: Properly tuning the Fermi level position in topological insulators is of vital importance to tailor their spin-polarized electronic transport and to improve the efficiency of any functional device based on them. Here, we report the full in situ metal organic chemical vapor deposition (MOCVD) and study of a highly crystalline $\text{Bi}_2\text{Te}_3/\text{Sb}_2\text{Te}_3$ topological insulator heterostructure on top of large area (4") Si(111) substrates. The bottom Sb_2Te_3 layer serves as an ideal seed layer for the growth of highly crystalline Bi_2Te_3 on top, also inducing a remarkable shift of the Fermi level to place it very close to the Dirac point, as visualized by angle-resolved photoemission spectroscopy. To exploit such ideal topologically protected surface states, we fabricate the simple spin-charge converter Si(111)/ $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3/\text{Au}/\text{Co}/\text{Au}$ and probe the spin-charge conversion (SCC) by spin pumping ferromagnetic resonance. A large SCC is measured at room temperature and is interpreted within the inverse Edelstein effect, thus resulting in a conversion efficiency of $\lambda_{\text{IEEE}} \sim 0.44$ nm. Our results demonstrate the successful tuning of the surface Fermi level of Bi_2Te_3 when grown on top of Sb_2Te_3 with a full in situ MOCVD process, which is highly interesting in view of its future technology transfer.

KEYWORDS: spintronics, topological insulators, Fermi level engineering, MOCVD, spin pumping, spin-charge conversion



INTRODUCTION

The use of topological matter for spintronics has been attracting huge interest since it paves the way toward highly energy-efficient and ultrafast devices.^{1–3} In particular, topological insulators (TIs) represent a very interesting case due to their unconventional electronic band structure.^{4,5} In principle, TIs are characterized by insulating bulk states (BS) and by linearly dispersed (i.e., Dirac-like) highly conductive topological surface states (TSS). A useful aspect of the TSS is their helical spin polarization arising from the so-called spin-momentum locking, where the spin of the electrons moving along a specific direction is locked orthogonally to their motion.⁴ Recently, TIs have been proposed as promising candidates to achieve efficient data read-out in the MESO devices proposed by Intel for future processing-in-memory architectures.^{1,6} TIs are of particular interest in implementing spintronic devices that are based on spin-charge conversion (SCC) mechanisms.^{7,8} The reciprocal effect, i.e., charge-spin conversion (CSC), has also been demonstrated at the interface between TIs and ferromagnetic (FM) layers, showing the great potentiality of TIs when compared to traditional heavy elements for spin-orbit torque-based devices.^{9,10}

However, most of the 3D-TIs, such as Bi_2Se_3 , Bi_2Te_3 , and Sb_2Te_3 , have their Fermi level (E_F) cutting the conduction or valence band. Therefore, the electrical conduction in TIs is often characterized by the superposition of conduction mechanisms originating from the TSS and the BS, the latter being detrimental to the optimization of both SCC and CSC in TIs-based devices.¹¹ In the specific case of Bi_2Te_3 , few reports exist discussing its use for SCC applications, mostly conducted at a low temperature.¹²

Several strategies have been proposed to engineer the position of the E_F so as to adjust it ideally at the crossing of the linearly dispersed bands of the TSS, i.e., close to the Dirac point (DP). One of the most widely attempted strategies is to control the TIs' stoichiometry by varying the molar fraction of the constituting elements. In the case of chalcogenide-based

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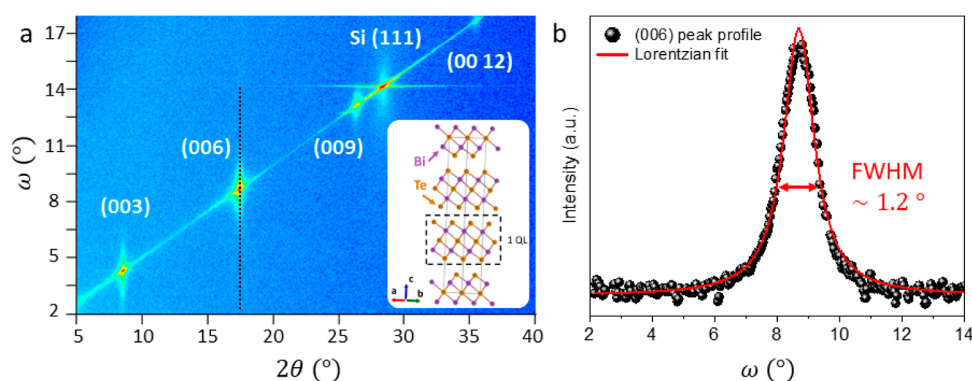


Figure 1. (a) XRD pattern acquired in the Bragg–Brentano geometry. The more intense signals (red elongated dots) indicate the OOP orientation of the Bi_2Te_3 crystalline planes [inset: Bi_2Te_3 crystalline structure drawn with the VESTA software,²⁶ according to the ICSD code 74348 and the definition of QL]. (b) Rocking angle profile of the (006) reflection [dotted line in panel (a)]. The acquired data are fitted with a Lorentzian curve to extract the value of the mosaicity for the OOP-oriented crystals, which corresponds to the FWHM of the peak.

3D-TIs, a notable example is given by the $(\text{Bi}_{1-x}\text{Sb}_x)_2\text{Te}_3$ family, for which Su et al.,¹³ Okada et al.,¹⁴ and Kondou et al.¹⁵ have demonstrated how fine control of the E_F position can be achieved by gradually changing the Sb content. In these works, the authors showed an enhanced SCC efficiency for a specific Sb concentration, where the Fermi level is rigidly shifted in the proximity of the DP. An alternative strategy consists of controlling the chemical doping of the TIs' surfaces. In fact, Hsieh et al.¹⁶ demonstrated that the modification of the Ca content in $\text{Bi}_{1-x}\text{Ca}_x\text{Te}_3$ compounds can increase the surface hole-donor concentration, which progressively pushes the E_F position toward the DP. Similarly, the use of interlayers between TIs and neighboring FM layers can also be used to intentionally engineer the band structure of a TI, finally enhancing the SCC efficiency in TI/FM heterostructures. For instance, Sun et al.¹⁷ reported in 2019 a study on the SCC mechanisms in $\text{Bi}_2\text{Se}_3/\text{Bi}/\text{FM}$ systems as a function of the Bi thickness. As a result, they have demonstrated the possibility to deeply modify the system, generating a Rashba-like 2D electronic gas band structure superimposed on the TSS of a Bi_2Se_3 layer, hence achieving full control of the SCC efficiency of the proposed heterostructure. The direct modification of the chemistry of a material is not the only way to engineer the Fermi level position. Interestingly, Du et al.¹⁸ have predicted that the internal strain present in a topological material (i.e., antiferromagnetic TI) can modify the position of the Fermi level due to the presence of defects and substitutional dopants in the structure.

An alternative strategy to move E_F toward the DP without chemically changing the nature of the TIs and without the use of voltage gating is to combine p and n-type materials. Eschbach et al. have presented the first effort of making a $\text{Bi}_2\text{Te}_3/\text{Sb}_2\text{Te}_3$ “p–n junction” by MBE, in which the E_F position of the top Sb_2Te_3 TI has been observed to change, depending on its thickness, with the E_F cutting the DP for 15 QL of Sb_2Te_3 .¹⁹ In line with this first experiment, others have followed, in which MBE has been employed to fabricate $\text{Bi}_2\text{Te}_3/\text{Sb}_2\text{Te}_3$ p–n junctions, where Sb_2Te_3 has always been chosen as the top TI.^{20,21}

In our previous work,¹¹ we investigated the topological properties of Bi_2Te_3 thin films grown by metal organic chemical vapor deposition (MOCVD) on 4" Si(111) substrates, demonstrating the presence of TSS lying in the bulk insulating gap of the material. Through angle-resolved photoemission spectroscopy (ARPES) measurements, the

Dirac-like dispersion of such surface states has been established, despite the position of the Fermi level being found to be within the conduction band of the material, as typically observed in Bi_2Te_3 . By performing magnetotransport experiments, a clear, weak antilocalization effect has been observed in Bi_2Te_3 and attributed to a 2D-type of conduction.¹¹ However, a remarkable contribution from the BS to the Bi_2Te_3 transport has still been evidenced, thus hindering the ideal contribution from the TSS. Indeed, it has already been shown by Wu et al.²² that the presence of BS at the Fermi level is a competitive transport mechanism which reduces the SCC performance of a TI, inhibiting pure quantum topological transport through the TSS.

In the wake of these considerations and inspired by previous attempts in making $\text{Bi}_2\text{Te}_3/\text{Sb}_2\text{Te}_3$ p–n junctions,^{19–21} in the present manuscript, we showcase the possibility of engineering the E_F position in MOCVD-produced Bi_2Te_3 thin films when grown on top of Sb_2Te_3 . To our knowledge, this is the first attempt at making a “reversed” $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ p–n junction in which Bi_2Te_3 is on top. Moreover, the use of MOCVD could have advantages when compared to MBE in view of future technology transfer. In particular, the commensurate growth of a 90 nm thick Bi_2Te_3 layer on top of a nearly epitaxial Si(111)/ Sb_2Te_3 seed substrate is conducted by optimizing a full in situ process, where the whole heterostructure is grown by MOCVD on Si(111) over an area up to 4". The structural properties of the obtained samples are studied by X-ray diffraction (XRD) performed in Bragg–Brentano geometry to assess their crystalline quality. Atomic force microscopy (AFM) is employed for direct visualization of the surface morphology and the roughness estimation of the Bi_2Te_3 layer. ARPES measurements on the $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ heterostructure are performed to probe the shifting of E_F in the Bi_2Te_3 top layer, and the obtained results are compared with those previously reported on the single Bi_2Te_3 layer directly deposited on Si(111).¹¹ In order to correlate the band engineering with the functionality of the proposed heterostructure, the deposited topological bilayer is coupled with a Au(5 nm)/Co(5 nm)/Au(5 nm) FM trilayer grown by evaporation, and spin pumping FMR resonance (SP-FMR) measurements are performed to extract the SCC efficiency of the system. The measured SP-FMR signals are interpreted by adopting the inverse Edelstein effect (IEE) model, from which a remarkable IEE length $\lambda_{\text{IEE}} \sim 0.44$ nm is extracted at room temperature for the $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ heterostructure, this being

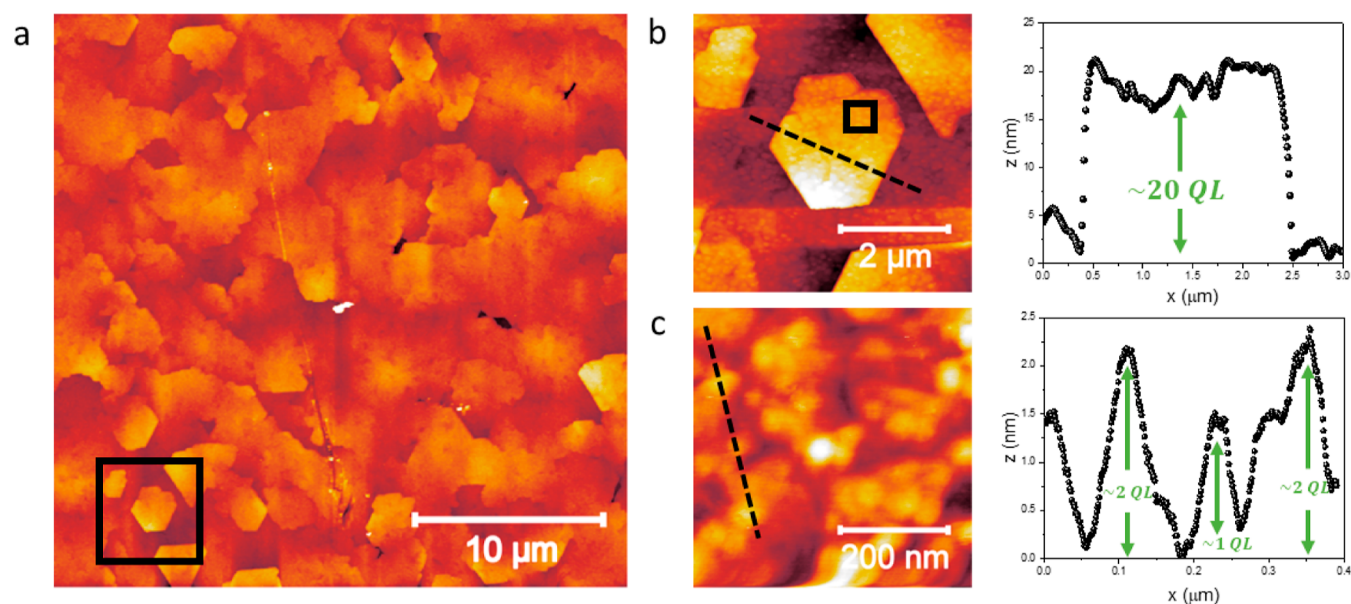


Figure 2. AFM measurement of the Bi_2Te_3 uncapped surface. (a) Scan area of $30 \times 30 \mu\text{m}^2$, where the presence of several hexagon-like flakes is clearly visible. In the inset, a $5 \times 5 \mu\text{m}^2$ scan of the area highlighted by the dashed black square in (a) is reported. The height profile of the Bi_2Te_3 flake is reported in panel (b). (c) Scan limited to a $0.5 \times 0.5 \mu\text{m}^2$ area is shown. From panel (c), we measure a morphological R_{RMS} of 0.69 nm.

a considerably high value within the class of chalcogenide-based 3D-TIs systems (see Table 1 of ref 23). Here, the adoption of the Au interlayer turns out to be beneficial to protect the Bi_2Te_3 TSS from degradation, avoiding uncontrolled interfacial intermixing, as has also been proven for similar systems.^{23–25}

RESULTS AND DISCUSSION

In Figure 1a the XRD pattern of the $\text{Si}(111)/\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ heterostructure acquired in the Bragg–Brentano geometry is depicted, and the inset shows the Bi_2Te_3 crystalline structure drawn with the VESTA software.²⁶ Through this measurement, the out-of-plane (OOP) orientation of the crystalline grains of the rhombohedral Bi_2Te_3 layer belonging to the $R\bar{3}m$ space group is extracted.²⁷ The only signals emerging from the contour plot shown in Figure 1a (red spots) correspond to the Bi_2Te_3 crystalline planes oriented along the $[00l]$ direction, as expected for highly ordered crystalline structures. To directly quantify the deviation from the full OOP orientation of the $(00l)$ planes with respect to the $\text{Si}(111)$ surface, the mosaicity of the Bi_2Te_3 layer is calculated by extracting the rocking curve around the (006) reflection (black dotted line in Figure 1a). In Figure 1b the variation of the signal intensity as a function of the rocking angle ω is reported and fitted with a Lorentzian curve (red solid line), where the full width at half-maximum (FWHM) represents the mosaicity of the film, corresponding to $(1.20 \pm 0.02)^\circ$. Remarkably, such a low value is comparable with that of chalcogenide thin films deposited by physical methods (i.e., molecular beam epitaxy).²⁸ The analysis of the Bragg–Brentano diffraction pattern and the quantification of the mosaicity suggest a nearly single-crystal fashion of the MOCVD-grown Bi_2Te_3 film.

To provide further insights into the surface morphology of the Bi_2Te_3 layer, AFM measurements are conducted on different areas of the sample. In Figure 2a, an AFM acquisition on a $30 \times 30 \mu\text{m}^2$ area of the Bi_2Te_3 bare surface is reported. Here, several in-plane-oriented Bi_2Te_3 hexagonal-like flakes are clearly visible, confirming the high crystalline nature of the

deposited film, its crystalline symmetry, and a remarkable in-plane order.²⁷

From the same picture, it turns out that some grains are merged in a more disordered fashion, a fact that does not always allow us to distinguish the shape of a single flake. This evidence is fully in accordance with the FWHM value extracted from the XRD analysis in Figure 1b, confirming the presence of Bi_2Te_3 regions with slightly disordered polycrystalline portions.

In Figure 2b, an AFM scan on a $5 \times 5 \mu\text{m}^2$ smaller area is performed to highlight the flake geometry and to precisely extract its height profile, as shown by the black solid square in panel (a). The right side of Figure 2b shows the linear profile corresponding to the black dashed line in the left picture of panel (b), from which it turns out that the height of the selected flake is approximately 20 nm, thus being composed of about 20 Bi_2Te_3 quintuple layers (QLs).

To have an estimation of the surface roughness within a single Bi_2Te_3 flake, an additional scan is performed on a $0.5 \times 0.5 \mu\text{m}^2$ area, as reported in Figure 2c. Here, a root mean square roughness (R_{RMS}) of 0.69 nm is extracted, a value which is sufficiently low to allow the possible integration of the MOCVD-grown Bi_2Te_3 with other materials, evidencing the very smooth morphology of the MOCVD-grown Bi_2Te_3 grains. However, the latter value is slightly higher than the one calculated for the bare $\text{Si}(111)/\text{Bi}_2\text{Te}_3$ reported in ref 27 for similar films, namely 0.5 nm.

The linear profiles acquired along the black dashed lines reported in Figure 2b,c show that the height of each step identifying a Bi_2Te_3 flake, or a smaller grain, is a multiple of a QL. Indeed, the Bi_2Te_3 structure is composed of QLs stuck together through van der Waals bonds (see inset of Figure 1a), demonstrating the very fine control of our MOCVD growth process.

The ARPES technique is ideal for conducting direct visualization of the band structure of the Bi_2Te_3 layers closer to the film's surface, Figure 3 shows a direct comparison between the band structure of Bi_2Te_3 when grown directly on $\text{Si}(111)$ (Figure 3a),¹¹ and on top of Sb_2Te_3 (Figure 3b). As

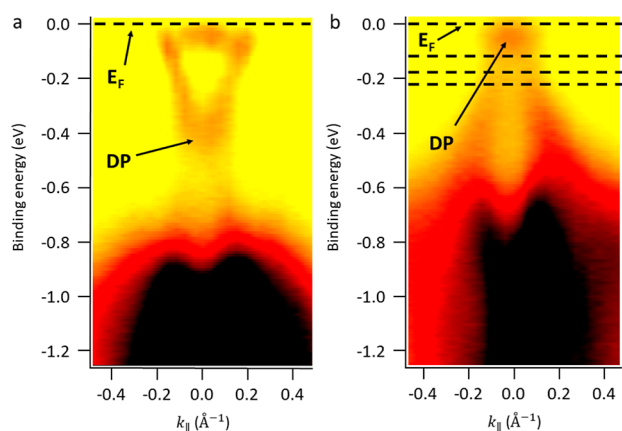


Figure 3. ARPES intensity map obtained for Si(111)/Bi₂Te₃, in panel (a), and Si(111)/Sb₂Te₃/Bi₂Te₃ heterostructures in panel (b). The black dashed lines in panel (b) indicate the different energies at which the contour plot is reported in Figure 4.

ARPES is extremely sensitive to the first few surface layers, a cleaning procedure is conducted prior to measurements to remove the surface contaminants (see [Methods](#) and [Supporting Information](#) for details).

As it emerges from the ARPES image reported in Figure 3a, in the bare Si(111)/Bi₂Te₃ heterostructure, the Fermi level is clearly positioned across the conduction band of the material, influencing the overall electronic transport, as revealed by magnetotransport measurements reported in ref 11. On the other hand, by comparing this result with panel (b) of the same figure, the Fermi level is rigidly shifted within the bulk insulating gap when the Sb₂Te₃ seed layer is placed between the Si substrate and Bi₂Te₃, intercepting the TSS in the proximity of the DP.

By comparing the two panels of Figure 3, it can be noticed that the Bi₂Te₃ grown on top of the Sb₂Te₃ seed layer shows a rigid shift of the band structure with respect to the layer grown on top of Si(111). A similar observation has been reported by Pereira et al.²⁰ for the reversed stack: Bi₂Te₃(bottom)/Sb₂Te₃(top), where the Sb₂Te₃ layer is subject to a modification of its band structure when just a few QLs are deposited, with a rigid shift of the chemical potential when a thicker layer is deposited. The latter condition is attributed to the different in-plane lattice constants of Sb₂Te₃ and Bi₂Te₃, being 0.42 and 0.44 nm, respectively. Such a 5% difference could induce an effective compressive (tensile) strain when Bi₂Te₃ is on top (bottom) to generate the observed chemical potential shift.

Even if we cannot exclude a slight change of the top Bi₂Te₃ thickness (within 10 nm in our estimation) when compared to the nominal 90 nm,^{27,29} this could hardly be the origin for the observed remarkable rigid shift of the E_F toward the DP that we observe (Figure 3), also according to recent literature reports.³⁰

Different ARPES polar maps are acquired in this work at room temperature for the Si(111)/Sb₂Te₃/Bi₂Te₃ system at various binding energies, with the aim of following the evolution of the band structure from the surface to the BS of the Bi₂Te₃ top layer. In Figure 4, we report the ARPES contour plots for $E = 0$ (Fermi level), -0.12 , -0.18 , and -0.22 eV, as indicated by the colored symbols marked in panel (b) of Figure 3.

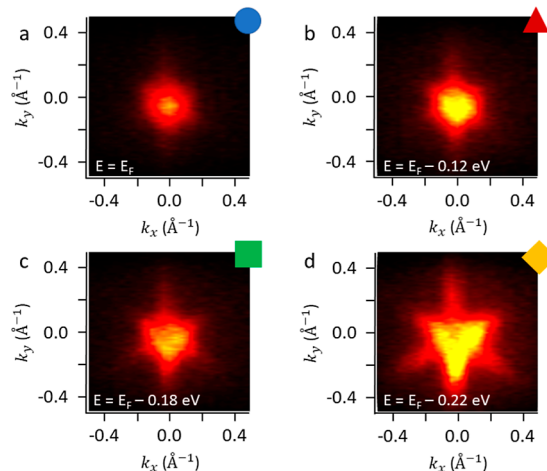


Figure 4. ARPES energy contour plots for the Si(111)/Sb₂Te₃/Bi₂Te₃ heterostructure. The K_x and K_y components are acquired along the K–G–K and M–G–M crystallographic directions in the k -space, respectively. The panels (a–d) marked with colored symbols indicate the various energy levels, as indicated in Figure 3b.

The pointwise symmetry of the contour plot in Figure 4a for $E = E_F$ indicates that the system lies in the proximity of the DP, a condition which highlights the 2D quantum transport properties of the Si(111)/Sb₂Te₃/Bi₂Te₃ heterostructure. For energies lower than E_F , the shapes of the spectra assume different geometries. At $E = -0.12$ eV, the hexagonal pattern appears, as expected for the symmetry rules of the TSS. Pushing down to $E = -0.18$ eV, a superposition between a hexagon and a triangular shape is observed, as a clear indication that the TSS and the BS are copresent at this energy. Finally, at $E = -0.22$ eV, the ARPES pattern is fully trigonal, therefore showing that the energy level is now solely crossing the Bi₂Te₃ BS.

The previous ARPES measurements represent a fundamental aspect of assessing whether the Si(111)/Sb₂Te₃/Bi₂Te₃ heterostructure possesses the prerequisites needed to exploit the topological transport in spintronic devices.

Having successfully moved the E_F close to the DP, it is now highly interesting to exploit the Bi₂Te₃ functionality for SCC by making use of SP-FMR. In SP-FMR, pure spin currents are generated in the FM layer and subsequently converted into charge currents flowing across the surface states of the TI.^{23,31} However, it is known that the direct contact between a FM and a TI can be detrimental for the TSS,^{15,23,25} so the adoption of appropriate nonmagnetic and low spin–orbit coupling interlayers is often beneficial to preserve the TSS and avoid chemical intermixing to successfully exploit SCC.^{23–25} We follow the same methodology as previously employed to probe SCC into Sb₂Te₃.^{23,25} In particular, we use Co as FM and Au as inter/capping-layers, with the following final stack structure (from the bottom): Si(111)/Sb₂Te₃/Bi₂Te₃/Au(5 nm)/Co(5 nm)/Au(5 nm). To properly estimate the SCC efficiency, the signals extracted by the functional heterostructure comprising the TI material are compared with a Si(111)/Au(5 nm)/Co(5 nm)/Au(5 nm) reference heterostructure prepared simultaneously during the same Au/Co/Au evaporation process. In the following, the Si(111)/Au/Co/Au and Si(111)/Sb₂Te₃/Bi₂Te₃/Au/Co/Au heterostructures are named S0 and S1, respectively.

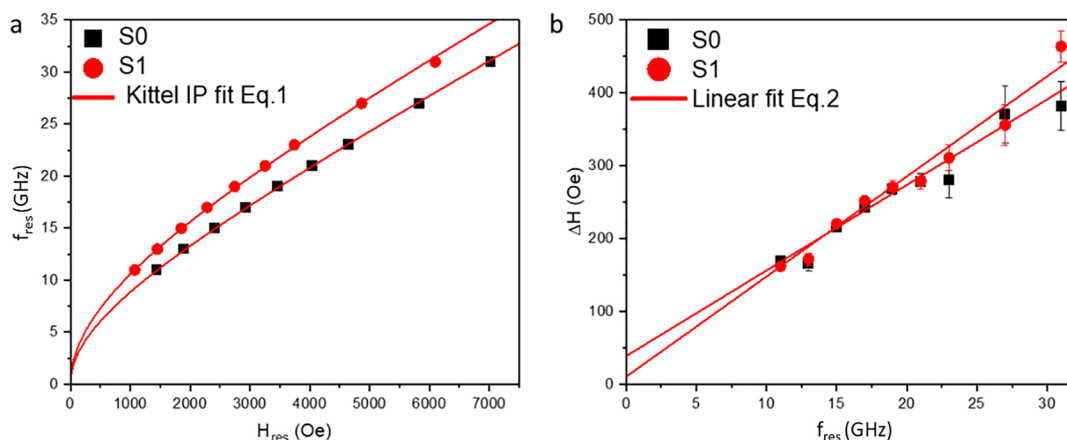


Figure 5. (a) Kittel dispersion for the IP configuration. The data set for the heterostructures S0 (black squares) and S1 (red circles) is reported and fitted with eq 1 (red solid line). (b) The signal line width as a function of the resonant frequency is reported for the same heterostructures of panel (a) and fitted with eq 2 (red solid line).

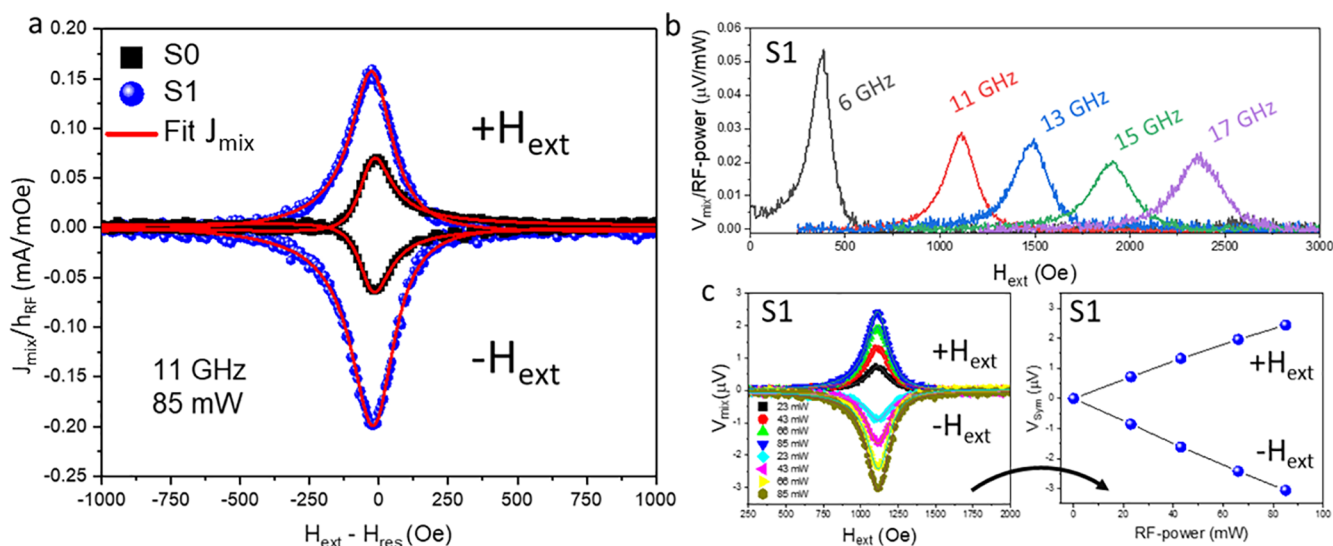


Figure 6. Electrically detected SP-FMR measurements. (a) 2D charge current generated in resonant condition and normalized to the strength of the oscillating magnetic field (h_{RF}) for the heterostructures S0 (black squares) and S1 (blue circles) at a frequency of 11 GHz and 85 mW of RF power. The red solid line indicates a fit with eq 3. (b) Frequency-dependent response for the heterostructure S1. (c) (left) V_{mix} vs H_{ext} curves as a function of the RF power acquired at positive and negative applied external magnetic fields for heterostructure S1. (right) Dependence of the voltage symmetric component V_{sym} as a function of the RF power for the curves reported in the left panel.

To extract the magnetization dynamics parameters necessary to quantify the SCC efficiency, broadband FM resonance (BFMR) measurements are performed.^{23,32} In Figure 5a, the Kittel curves acquired for heterostructures S0 and S1 are reported (black squares and red circles, respectively), where the resonant frequency (f_{res}) is plotted as a function of the resonant magnetic field (H_{res}) (see Methods). The evolution of the $f_{res}(H_{res})$ response is acquired over a large frequency range (11–30 GHz) to ensure reliable quantification of the parameters extracted from the fit with eq 1 (red solid line). For a polycrystalline FM thin film positioned in the in-plane (IP) configuration, the Kittel equation can be expressed as

$$f_{res} = \frac{\gamma}{2\pi} \sqrt{H_{res}(H_{res} + 4\pi M_{eff})} \quad (1)$$

where γ is the gyromagnetic ratio, M_{eff} is the effective magnetization, $\gamma = g \frac{e}{2m_e} \left[\frac{Hz}{Oe} \right]$, where e and m_e are the charge and the mass of the electron, respectively, and g is the Landé g -

factor, a quantity which links the electronic angular and spin momenta of a material.³³

After extracting the M_{eff} value from eq 1, some information on the magnetic anisotropy can be achieved by writing the relation $4\pi M_{eff} = 4\pi M_s - H_k = 4\pi M_s - \frac{2K_s}{M_s t_{Co}}$, where M_s , t_{Co} , H_k , and K_s are the saturation magnetization, the thickness of the Co layer, the magnetic anisotropy field, and the surface magnetic anisotropy constant, respectively.

Adopting the same methodology as refs 23 and 25, from the fit of the Kittel dispersion reported in Figure 5a, we obtain $\gamma^{S0} = (1.91 \pm 0.01) \cdot 10^7 \frac{Hz}{Oe}$ ($g^{S0} = 2.17 \pm 0.01$) and $\gamma^{S1} = (1.85 \pm 0.04) \cdot 10^7 \frac{Hz}{Oe}$ ($g^{S1} = 2.15 \pm 0.05$). The extracted g values are very similar and perfectly in agreement with most of those found in the literature ($g \sim 2.25$). The corresponding effective magnetizations are $M_{eff}^{S0} = 609 \pm 9 \frac{emu}{cm^3}$ and $M_{eff}^{S1} = 973 \pm 59 \frac{emu}{cm^3}$ for S0 and S1, respectively. These values

are lower than the Co bulk value ($\sim 1400 \frac{\text{emu}}{\text{cm}^3}$),³⁴ as typically observed in thin films, due to the possible presence of magnetic dead layers and/or magnetic shape anisotropy.³⁵

In Figure 5b, the line width ΔH of the BFMR signal is plotted as a function of f_{res} and fitted according to the following eq 2.

$$\Delta H = \Delta H_0 + \frac{4\pi}{|\gamma|} \alpha f_{\text{res}} \quad (2)$$

where α represents the damping constant, and ΔH_0 represents the inhomogeneous broadening. From the FMR theory,^{33,36} α accounts for how fast the magnetization vector M in a FM aligns along an applied external magnetic field at the resonance condition.³³ According to the linear fit (red solid lines) of the data sets reported in Figure 5b, the values $\alpha^{S0} = (17.9 \pm 1.3) \times 10^{-3}$, $\Delta H_0^{S0} = 38 \pm 13$ Oe, $\alpha^{S1} = (20.3 \pm 1.2) \times 10^{-3}$, and $\Delta H_0^{S1} = 10 \pm 12$ Oe are extracted. ΔH_0 provides information on the magneto-structural properties of the FM layer, accounting for sample imperfections or texturing. This value is acceptable and comparable for both samples, indicating a limited amount of magnetic disorder in the Co layer (i.e., magnetic dead layers, structural imperfections, etc.).

According to the spin pumping theory,^{31,37} the difference between the α values calculated for S0 and S1 is proportional to the real part of the spin mixing conductance $\text{Re}(g_{\text{eff}}^{\uparrow\downarrow})$ characterizing the interface between the FM and the adjacent spin-sink layer, in this case the Bi_2Te_3 layer. $\text{Re}(g_{\text{eff}}^{\uparrow\downarrow})$ is an intrinsic quantity of a system which accounts for the pure spin current flowing across the interface toward the Bi_2Te_3 . In our case, by considering the measured $\Delta\alpha = (2.4 \pm 2.5) \times 10^{-3}$, we obtain $\text{Re}(g_{\text{eff},\text{Bi}_2\text{Te}_3}^{\uparrow\downarrow}) = 7.53 \times 10^{18} \text{ m}^{-2}$, a value perfectly in agreement with those extracted elsewhere for similar systems (see Table 1 ref 23). For details about the procedure to extract the latter value, see the Supporting Information.

The enhancement of α alone is necessary but not sufficient evidence to conclude the existence of SCC, which can only be demonstrated by electrically detecting the spin pumping signal. In Figure 6, the electrically detected SP-FMR measurements carried out on the S0 and S1 heterostructures are shown. A detailed description of the experimental procedure and the theoretical background can be found both in ref 23 and partially in the Supporting Information.

In Figure 6a, the mixing charge current density J_{mix} is plotted for the heterostructures S0 (black squares) and S1 (blue circles), where the red solid lines indicate the fit of both curves, as obtained by the following Lorentzian function of eq 3.

$$\begin{aligned} \frac{J_{\text{mix}}}{h_{\text{RF}}} &= \frac{V_{\text{mix}}}{WRh_{\text{RF}}} \\ &= \frac{1}{WRh_{\text{RF}}} \left[V_{\text{Sym}} \frac{\Delta H^2}{\Delta H^2 + (H - H_{\text{res}})^2} \right. \\ &\quad \left. + V_{\text{Asym}} \frac{\Delta H(H - H_{\text{res}})}{\Delta H^2 + (H - H_{\text{res}})^2} \right] \quad (3) \end{aligned}$$

where h_{RF} , W , and R represent the transverse oscillating magnetic field, the width of the heterostructure, and its sheet resistance, respectively. In this case, the adopted values are $h_{\text{RF}} = 0.73$ Oe, $W_{S0} = 2$ mm, $W_{S1} = 2$ mm, $R_{S0} = 16 \Omega$, and $R_{S1} = 16 \Omega$ (measured with a four-point probe). From such a fit, it is possible to isolate the symmetric component of the curve, which is proportional to the so-called symmetric voltage, V_{Sym} ,

and directly connected to the spin pumping taking place at the TI/FM interface. Differently, the asymmetric part ($\propto V_{\text{Asym}}$) depends on spurious rectification effects (i.e., Oersted field, anisotropic magnetoresistance, etc.), thus being excluded from the estimation of the SCC mechanism.^{38,39} The curves in Figure 6a are highly symmetric, indicating that the rectification effects are not the main processes driving the electrical response in both heterostructures. Despite the similar shape of these curves, the intensity of the electrical signals generated from S1 is much higher than that in S0 at the same RF power, suggesting that the insertion of the $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ bilayer is beneficial to generate a higher charge current density in S1 when compared to the reference S0. In order to remove a possible thermal component (i.e., Seebeck effect⁴⁰) from the symmetric part of J_{mix} , the actual signal arising from SP is obtained by mediating the symmetric part of the J_{mix} curves acquired for positive and negative magnetic fields, according to

the equation $\frac{J_{\text{SP}}}{h_{\text{RF}}} = \frac{1}{h_{\text{RF}}} \left[\frac{J_{\text{Sym}}(+H_{\text{ext}}) - J_{\text{Sym}}(-H_{\text{ext}})}{2} \right]$. The extracted

values are $\frac{J_{\text{SP}}^{S0}}{h_{\text{RF}}} = 0.064 \pm 0.005$ mA/Oe,

$\frac{J_{\text{SP}}^{S1}}{h_{\text{RF}}} = 0.180 \pm 0.001$ mA/Oe, $\frac{J_{\text{Asym}}^{S0}}{h_{\text{RF}}} = 0.027 \pm 0.006$ mA/Oe,

and $\frac{J_{\text{Asym}}^{S1}}{h_{\text{RF}}} = 0.024 \pm 0.002$ mA/Oe. For a quantitative estimate

of the extra-current produced in S1 when compared to S0, we underline here the ratio $\frac{J_{\text{SP}}^{S1}}{J_{\text{SP}}^{S0}} = 2.84 \pm 0.24$, representing clear

and direct evidence for the role played by the insertion of the $\text{Sb}_2\text{Te}_3/\text{Bi}_2\text{Te}_3$ heterostructure in generating a remarkable SCC. As a further confirmation that the SCC mechanism observed in S1 (Figure 6a) is consistent with the spin pumping effect, in Figure 6b the SP-FMR signals acquired for different RF frequencies are reported, demonstrating the relation between the measured voltage and the BFMR characteristic of the system. Moreover, the V_{Sym} component of the IEE signal should be linear when plotted as a function of the RF power, as shown in Figure 6c.⁴¹

In a spin pumping experiment, the SCC efficiency can be estimated mainly according to two models: the inverse spin-hall effect (ISHE) and the IEE. For the ISHE, the spin current generated into the FM layer is pumped and converted in the BS of the spin-sink layer (i.e., Bi_2Te_3), differently from the IEE, where solely the TSS are involved in the SCC. In our case, we performed several trials to measure the SCC in the interlayer-free $\text{Bi}_2\text{Te}_3/\text{Co}$ heterostructure, but no significant SP was observed with respect to the reference heterostructure, as in the case of the Sb_2Te_3 TI previously investigated by some of us.^{23,25} Few works exist reporting the SCC effects in Bi_2Te_3 films directly in contact with the FM layer. For instance, in the very recent work of Liu et al.,¹² the authors have observed an efficient spin current injection in the $\text{Bi}_2\text{Te}_3/\text{MnTe}$ heterostructure only at $T < 25$ K, with a significant reduction around 100 K. Conversely, the introduction of interlayers at the $\text{Bi}_2\text{Te}_3/\text{FM}$ interface is a reliable strategy to improve the SCC efficiency, as demonstrated by Li et al.⁴² adopting a $\text{BN}/\text{Al}_2\text{O}_3$ tunneling barrier.

The most plausible scenario in our case is that the Au interlayer is beneficial in protecting Bi_2Te_3 's TSS detected by ARPES (Figure 3), similarly to what has occurred in Sb_2Te_3 .^{23,25} Therefore, the observed SCC can be represented in terms of the IEE, where the IEE diffusion length

$\lambda_{\text{IEE}} = \frac{J_{\text{SP}}}{J_{\text{s}}^{3\text{D}}}[\text{nm}]$ is adopted as a figure of merit to determine the conversion efficiency, with $J_{\text{s}}^{3\text{D}}$ being the spin current density generated in the system (see Supporting Information). According to the parameters reported in Figure 6a and to the FMR response in Figure S, we have $J_{\text{s}}^{3\text{D}} = 2.97 \times 10^5 \text{ A m}^{-2}$, and therefore,

$$\lambda_{\text{IEE}} = \frac{J_{\text{SP}}}{J_{\text{s}}^{3\text{D}}} \sim \frac{J_{\text{sym}} h_{\text{RF}}}{J_{\text{s}}^{3\text{D}}} \sim \frac{0.00013 \text{ A m}}{2.97 \cdot 10^5 \text{ A m}^{-2}} \sim 0.44 \text{ nm.}$$

Despite our evidence being consistent with the IEE, the origin of the voltage signals in SP-FMR experiments is often highly debated (see Supporting Information).^{43–45} For the sake of clarity, a different fitting approach can be performed by fixing $g \sim 2.25$ in eq 1 from the averaging of some values found in the literature for Co thin films. In this case, λ_{IEE} would be ~ 0.40 nm, in strong accordance with the value reported above.

By comparing the λ_{IEE} extracted here with some of those found in the literature, we can infer that the 0.44 nm value calculated in our MOCVD-deposited heterostructure is a very large one (see Table 1 ref 23). If we refer only to the SCC efficiency extracted from different chalcogenide-based topological compounds, it emerges that this value is among the highest reported so far at room temperature. Notably, TI-based systems to compare with are, for example, those reported by Mendes et al.⁴⁶ with $\lambda_{\text{IEE}} = 0.075$ nm in $(\text{Bi}_{0.22}\text{Sb}_{0.7})_2\text{Te}_3$, or $\lambda_{\text{IEE}} = 0.28$ nm in Bi_2Se_3 reported by Sun et al.,¹⁷ and recent works by some of us,^{23,25} showing that $\lambda_{\text{IEE}} = 0.28$ nm for a 30 nm thick Sb_2Te_3 epitaxial TI. Also, among the possible different interlayers, the choice of Au seems to be particularly favorable. As a comparison, in the work from He et al.,⁴⁷ published in 2021, the authors exploited Ru and Ti interlayers in Bi_2Te_3 /interlayer/CoFeB systems, extracting λ_{IEE} values ten times smaller than those we extract here.

CONCLUSIONS

The need to properly tune the Fermi level position in TIs is of paramount importance to fully make use of their topologically protected spin-polarized electronic transport. In this work, we report a full in situ MOCVD process where highly crystalline 90 nm thick Bi_2Te_3 thin films are grown on top of epitaxial Sb_2Te_3 layers over 4" Si(111) substrates. The use of Sb_2Te_3 as a seed layer turns out to be a valid strategy to shift the Bi_2Te_3 's Fermi level from the conduction band (as it occurs in single Bi_2Te_3 layers) to the insulating gap in very close proximity to the DP, as clearly visualized by room-temperature ARPES measurements. This generates ideally pure TSS, which we exploit in a simple spin-charge converter by conducting SP-FMR measurements. A remarkably high SCC efficiency is measured in the Si(111)/ Sb_2Te_3 / Bi_2Te_3 /Au/Co/Au heterostructure, and by interpreting such a conversion within the IEE, we extract a high conversion efficiency of $\lambda_{\text{IEE}} \sim 0.44$ nm at room temperature. Here, we demonstrate that the full in situ MOCVD growth of the Bi_2Te_3 / Sb_2Te_3 heterostructure is successful in producing a TI characterized by ideal topologically protected surface states and that those states can directly be exploited for efficient SCC. This work paves the way for the future adoption of chemically deposited Bi_2Te_3 thin films on a large area Si wafer, thanks to the highly efficient SCC achieved via Fermi-level engineering.

MATERIALS AND METHODS

A nominally 90 nm thick Bi_2Te_3 layer^{27,29} is grown on a 4" Si(111)/ Sb_2Te_3 (30 nm) wafer by means of MOCVD. Prior to the deposition

of Sb_2Te_3 , the Si(111) substrate is treated by means of HF acid to remove the native oxide, and an annealing process is performed to properly reconstruct the Si surface. Following the substrate conditioning, the growth of the seed layer of Sb_2Te_3 is performed at room temperature for 90 min and at a pressure of 15 mbar. The deposition is then followed by post-growth annealing, which is needed to promote further crystallization. Without removing the sample from the reactor, the chamber is brought to 350 °C, and the deposition of the layer of Bi_2Te_3 is performed at 75 mbar for 190 min. The growth parameters of the two TI layers are kept unchanged with respect to those employed to grow the Sb_2Te_3 and Bi_2Te_3 single layers on top of Si(111), as reported in refs 27 and 29.

The Si(111)/ Sb_2Te_3 / Bi_2Te_3 heterostructures dedicated to the SP-FMR studies are cut into smaller pieces and transferred into an Edwards Auto306 e-beam evaporation tool, together with the Si(111) reference substrates. A simultaneous deposition of the Au(5 nm)/Co(5 nm)/Au(5 nm) trilayer is conducted for all the heterostructures. The Si(111) substrates used as references are cleaned with isopropyl alcohol and treated with HF prior to the evaporation processes.

The Bragg–Brentano XRD pattern is acquired by an HRXRD IS2000 diffractometer equipped with a Cu K_{α} radiation source ($\lambda = 1.5406 \text{ \AA}$), a four-circle goniometer, and a curved 120° position-sensitive detector (Inel CPS-120). This configuration allows the detection of the asymmetric reflections produced by the crystalline planes not perfectly parallel to the sample surface, giving access to the value of the mosaicity of the crystalline grains composing the material.

AFM images are obtained using a Bruker dimension edge instrument operating in the tapping mode and using a sharp silicon AFM probe (TESPA, Bruker) with a typical radius of curvature in the 8–12 nm range. A polynomial background correction is applied to the raw data. To quantify the morphological surface, the root mean square roughness (RMS roughness, R_q) value is adopted and expressed in nanometers. The different AFM images reported in the main text represent three independent measurements acquired on $30 \times 30 \mu\text{m}^2$, $5 \times 5 \mu\text{m}^2$, and $0.5 \times 0.5 \mu\text{m}^2$ areas.

ARPES spectra are acquired at room temperature with a 100 mm hemispherical electron analyzer equipped with a 2D CCD detector (SPECS). The He I (21.22 eV) resonant line is employed to excite photoelectrons, yielding an energy resolution of 40 meV. The spot of the employed ARPES facility has an elliptical shape with an area of about $4 \times 6 \text{ mm}^2$. Thanks to this, the ARPES characterization conducted on our samples makes it possible to extract information about the dispersion of the material band structure in a relatively macroscopic area. ARPES is performed ex situ, so a two step surface cleaning procedure is needed to remove the oxidized species and contaminants, namely surface ion sputtering (Ar^+ at 1.5 keV) and an annealing treatment at 270 °C. Subsequently, the film surface is probed with reflection high-energy electron diffraction and X-ray photoemission spectroscopy to verify the effectiveness of the treatments (see Supporting Information).

BFMR is performed using a broadband Anritsu-MG3694C power source (1–40 GHz), connected to a grounded coplanar waveguide, where the samples are mounted in a flip-chip configuration (the FM film is located close to the GCPW surface) with a 75 μm thick Kapton foil stacked in between to prevent the shortening of the conduction line. The sample-GCPW system is positioned between the polar extensions of a Bruker ER-200 electromagnet, maintaining its surface parallel to the external magnetic field H_{ext} , in the so-called in-plane (IP) configuration. During the measurements, an RF current at a fixed frequency is carried toward the GCPW, and the transmitted signal is directed to a rectifying diode, converting the RF signal into a continuous DC current, subsequently detected by a lock-in amplifier downward the electronic line. The same instrumentation is adopted to conduct SP-FMR measurements. Here, the edges of the sample are in contact with Ag paint and connected to a nanovoltmeter. A DC voltage is detected under resonant conditions, fixing the RF frequency and power.

■ ASSOCIATED CONTENT

■ Supporting Information

The Supporting Information is available free of charge at <https://pubs.acs.org/doi/10.1021/acsami.3c08830>.

Grazing Incidence XRD on Si(111)/Sb₂Te₃/Bi₂Te₃; estimation of the spin mixing conductance and spin current density from FMR experiments; alternative calculation to estimate the SCC efficiency according to the Inverse Spin Hall Effect (ISHE); and XPS and RHEED measurements of the Si(111)/Sb₂Te₃/Bi₂Te₃ surface (PDF)

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Notes

The authors declare no competing financial interest.

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